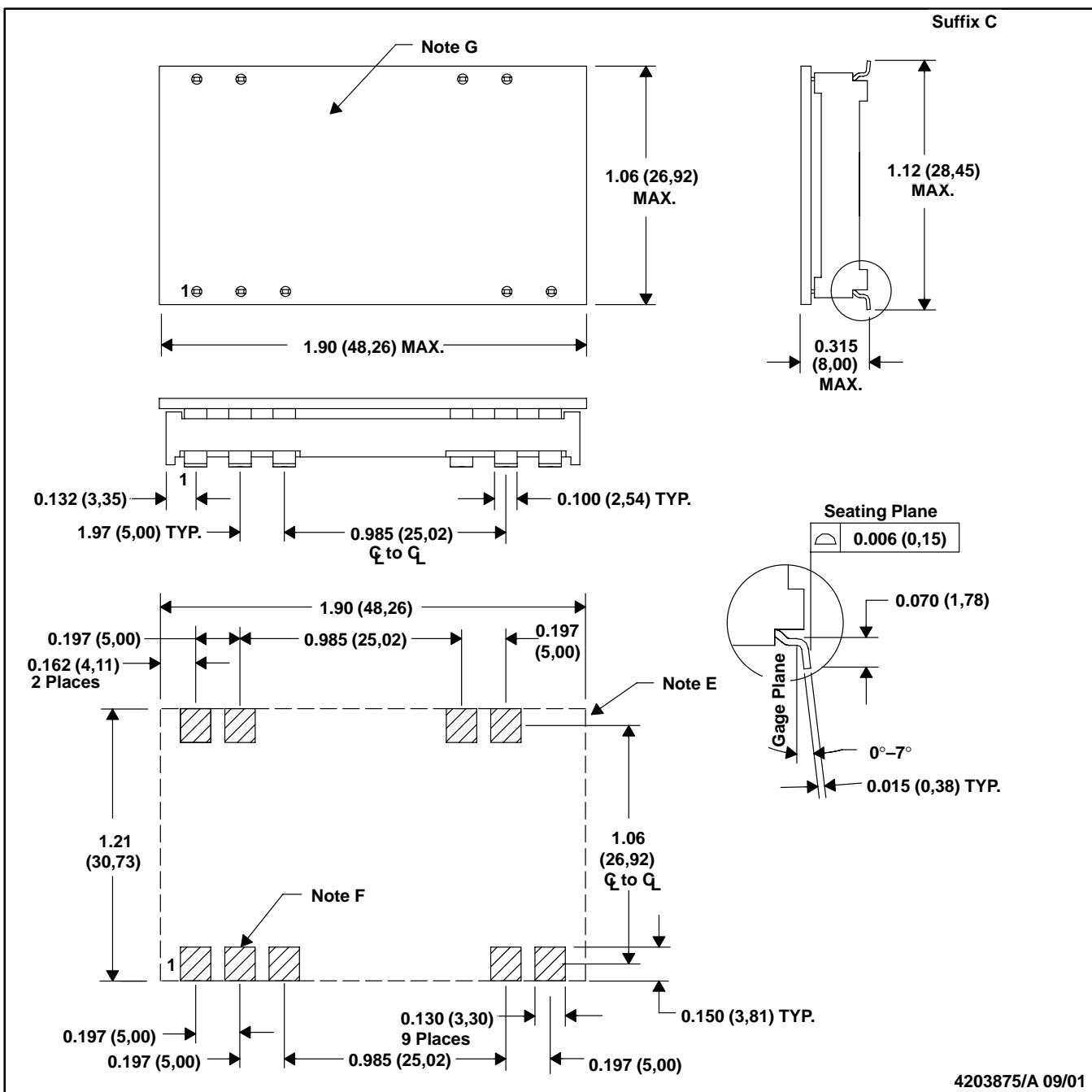


EGL (R-PDIP-G9)

PLASTIC DUAL-IN-LINE MODULE



NOTES:

- All linear dimensions are in inches (mm).
- This drawing is subject to change without notice.
- 2 place decimals are ± 0.030 (± 0.76 mm).
- 3 place decimals are ± 0.010 (± 0.25 mm).
- Recommended mechanical keep out area.
- Power pin connection should utilize two or more vias per input, ground and output pin.
- Keepout area, printed circuit board exposed (Top View).

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